## IN THE UN

## 07-28-2000

ADEMARK OFFICE

Docket No.: SONY-50N3460.01

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Class Po	certify that thi ostage and add elow date of de	iressed to the U	he below des .S. Patent an	cribed document is to d Trademark Office,	eing depos Assignment	ited with the United State Branch, North Tower Bu	es Postal Service in an ilding, Suite 10C35, Wa	envelope bearing First shington, D.C., 20231,	
Date of Deposit:	07/14/0	Name of	Person le Deposit:	Anthony Chou		gnature of the Person aking the Deposit:	Tothe a	hou	
Wash Sir:	ington, D.C			nts ocument(s) or c	opy(ies)	thereof:	00000	15659	
				Transmitta	l of an A	ssignment		09/6	
	me of conv ty(ies):	eying ]	Eiji Ka	asahara				Ö	
•	rial No.:	0		Group Art Unit: Examiner:					
3. N	Receiving party(ies)  Shinagawa-ku, Tokyo, Japan  SONY OF ELECTRONICS, INC., 1 Sony Drive, Park Ridge, New Jersey, 0765								
4. N	ew Patent	Application	entitled:			SYSTEM FOR I	DEBUGGING A		
5. N	ame and a Name: Address Phone	Ant Way Two	hony C. M gner, Mura	furabito abito & Hao LLF arket Street, Th	<b>5</b>	ncerning documer , San Jose, CA 98		ed:	
<b>6.</b> To	otal Numbe	er of applica	tions and	patents involve	d: ONE				
<ul> <li>7. Fee Calculation (for other than a small entity)         Assignment Recordation Fee, per property         Total Fees (37 CFR 3.41)         X The amount of \$ 40.00 is enclosed     </li> </ul>							1 <b>X</b> \$40.00	\$40.00	
						se charge any add copy of this trans			
9. St	atement and	d signature:							
	best of my k al document.	nowledge and	belief, the J	foregoing informat	tion is tru	e and correct and any		.~~>	
Date:	07/14/0	0				Name: Anthony C. Reg. No. 35,295	Murabito §		

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**REEL: 010944 FRAME: 0884** 

Attorney Docket No.: SONY-50N3460.01

## Assignment To SONY Corporation and SONY Electronics, Inc.

Inventor's Signature:

RECORDED: 07/14/2000

In consideration of good and valuable consideration, receipt of which is hereby acknowledged, I/we Eiji Kasahara do hereby sell, assign, and transfer unto SONY Corporation and SONY Electronics, Inc. (hereinafter called the Assignees), a Corporation of Delaware and its successors and assigns, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements, including the right of priority in, to, and under, the application for the United States patent entitled: METHOD AND SYSTEM FOR DEBUGGING A MICROPROCESSOR CORE filed herewith and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor; or and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor: And for the above consideration, I/we agree promptly upon request of the Assignees, their successors or assigns, to execute and deliver without further compensation any power of attorney, assignment, application, whether original, continuation, divisional or reissue, or other papers which may be necessary or desirable fully to secure to the Assignees, their successors and assigns, the inventions described in said application and all patent rights therein, in the United States and in any country foreign thereto, and to cooperate and assist in the prosecution of interference proceedings involving said inventions and in the adjudication or reexamination of said Letters Patent provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by the Assignees. I/we further covenant with the Assignees, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license. or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned; In witness whereof, I/we hereunto set my/our hand(s) and seal: Eiji Kasahara Date: 7/12/00

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